

EDUCATION

University of Florida, Gainesville, USA	Aug. 2024
<i>Ph.D. in Electrical and Computer Engineering GPA: 4.0/4.0</i>	
<i>Core Courses: Semiconductor Device Fabrication, Nanodevices, Principles & Design of MEMS Transducers, Resonant MEMS, Optical Engineering, Biophotonics, Laser Theory and Design, Quantum Devices & Quantum Engineering, Applied Magnetic and Magnetic Materials.</i>	
Northeastern University, China	Jan. 2019
M.S. in Fluid Mechanics and Engineering GPA: 87.34/100, Ranking: 1/367	
Northeastern University, China	Jun. 2016
B.E. in Process Equipment & Control Engineering GPA: 88.99/100, Ranking: 1/67 & 4/560	

EXPERIENCE

Postdoctoral Scholar	University of California, Berkeley
Mechanical Engineering Department	Aug. 2024-Present
Research Interests: The design, fabrication and implementation of sensing systems for intelligent construction and smart living.	
R&D Co-Op (BAW Modeling & Simulation)	Skyworks Solutions, Inc, Irvine, CA
Department of Acoustic Engineering, Technology & Manufacturing Group	Aug. 2023-Dec. 2023
Systems Engineer Intern	Applied Materials, Inc, Santa Clara, CA
Engineered Optics, Office of the CTO at Applied Materials	May. 2022-Aug. 2022
Graduate Research Assistant (PhD)	University of Florida
Interdisciplinary Microsystems Group,	Aug. 2019-Present
Research Interests: Wide Bandgap (WBG) MEMS & NEMS for Harsh Environment Applications (High Temperature, Radiation, etc.), Piezoelectric MEMS & NEMS, Lamb Wave Resonators (LWR), Bulk Acoustic Wave Resonators (BAW), High Temperature Internet of Things (IoT) Sensors, Optomechanics.	
Thrust I: Wide Bandgap (WBG) Semiconductor MEMS for High Temperature Application	
◆ Micromachined AlScN-on-SiC Resonant Transducers Operating in High-Temperature Environment	
◆ Thermal Response of GaN/AlN Heterostructure Multimode Micro String Resonators	
◆ GaN MEMS Lamb Wave Resonators Operating at High Temperature up to 800°C	
Thrust II: Radiation Effects on MEMS Resonators	
◆ Effects of Ion-Induced Displacement Damage on GaN/AlN MEMS Resonators	
◆ Probing Heavy Ion Radiation Effects on Mechanical Properties of Silicon Micromechanical Resonators	
Thrust III: MEMS IoT Sensor	
◆ Micromachined Thin Film Ceramic PZT Multimode Resonant Temperature Sensor	
◆ Integrated Graphene NEMS Temperature Sensor	
Thrust IV: Pressure Sensing Based on Ultra-Wide Bandgap (UWBG) Semiconductor NEMS	
◆ Surface Adsorption and Air Damping Behavior of β -Ga ₂ O ₃ Nanomechanical Resonators	
Graduate Research Assistant (Master)	Northeastern University
Lab of Vacuum and Thin Films Device,	Aug. 2016–Jan. 2019
Thrust I: Mechanical Strain Effects on Resistive Switching of Flexible Memory Device	
Oct. 2017–Jan. 2019	
◆ Mechanical Strain Effects on Resistive Switching of Flexible Polymer Thin Films Embedded with ZnO Nanoparticles	

- ◆ Interfacial Effects on Resistive Switching of Vacuum Spray Deposited Polymer Thin Films Embedded with TiO₂ Nanoparticles Under Bending Strain

Thrust II: Temperature Effects on Resistive Switching and Charge Transport

Oct. 2017–Jan. 2019

- ◆ Temperature Dependent Electron Transport In Oligo (3-methylthiophene) Derivative Molecular Devices
- ◆ Temperature-Dependent Fatigue Failure of Flexible Poly(9,9-dioctylfluorene-alt-benzothiadiazole) (PFBT)–ZnO Nanoparticle Hybrid Resistive Switching Memory Devices

Thrust III: High Density Information Storage based on Organic-inorganic Hybrid Devices Jun. 2016–Dec. 2017

- ◆ Interfacial Effects on Resistive Switching of Polymer Films Embedded With Different Nanomaterials

TEACHING AND TUTORING EXPERIENCE

ECE, University of Florida

Gainesville, USA

Teaching Assistant of EEL3008 Physics of EE

Spring 2022

Teaching Assistant of EEL4930&5934 Introduction to Quantum Devices and Quantum Engineering

Fall 2021

School of Mechanical Engineering and Automation, Northeastern University

Shenyang, China

Position: Teaching Assistant of Vacuum Physics Technology and Measurement Technique

Fall 2015

- ◆ Instructed undergraduates experimental operations in vacuum evaporation coating and vacuum magnetron sputtering machine

TECHNICAL SKILLS

- ◆ 4+ Year Experience in Micro/Nano Semiconductor Fabrication
 - ◆ Photo Lithography, E-beam Lithography, Wet Etch, Dry Etch, Film Deposition, Focused Ion Beam (FIB), etc.
- ◆ Finite Element Analysis Software: COMSOL Multiphysics, Abaqus
- ◆ CAD & CAM Software: SolidWorks, Sharp3D, AutoCAD, 3DsMax
- ◆ Mathematic Software: Matlab, Mathematica
- ◆ Statistical Software: JMP
- ◆ Computer Programming: LabVIEW, Python
- ◆ Optical Measurement: Optical Laser Interferometer
- ◆ Electrical Measurement: Probe Station, Spectrum Analyzer, Network Analyzer & Semiconductor Characterization System, Phase-Locked Loop (Zurich)
- ◆ Microscope: Raman Spectroscopy, SEM, TEM, AFM
- ◆ Quantum Chemistry: Gaussian-09 Package, Atomistic Tool Kit (ATK)
- ◆ General Engineering Software: Origin, Microsoft Visio, CorelDRAW, etc

PEER-REVIEWED JOURNAL PAPERS & PATENT

- ◆ **Wen Sui**, Philip X.-L. Feng, "AlScN-on-SiC MEMS Lamb Wave Resonators Operating at High Temperature up to 800°C", *Applied Physics Letter* **125**, 022201 (2024). DOI: [10.1063/5.0185606](https://doi.org/10.1063/5.0185606).
- ◆ **Wen Sui**, S M Enamul Hoque Yousuf, Yuncong Liu, Stephen J. Pearton, and Philip X.-L. Feng, "Surface Adsorption and Air Damping Behavior of β -Ga₂O₃ Nanomechanical Resonators", *Advanced Material Technologies* **9**, 2301356 (2024). DOI: [10.1002/admt.202301356](https://doi.org/10.1002/admt.202301356).
- ◆ **Wen Sui**, Tahmid Kaiser, Haoran Wang, Yihao Wu, Jaesung Lee, Huikai Xie, Philip X.-L. Feng, "Micromachined Thin Film Ceramic PZT Multimode Resonant Temperature Sensor", *IEEE Sensors Journal* **24**, 7273-7283 (2024) DOI: [10.1109/JSEN.2023.3294125](https://doi.org/10.1109/JSEN.2023.3294125).
- ◆ **Wen Sui**, Haoran Wang, Jaesung Lee, Afzaal Qamar, Mina Rais-Zadeh, Philip X.-L. Feng, "AlScN-on-SiC Thin Film Micromachined Resonant Transducers Operating in High-Temperature Environment up to 600°C", *Advanced Functional Materials* **32**, 2202204 (2022). DOI: [10.1002/adfm.202202204](https://doi.org/10.1002/adfm.202202204).
- ◆ **Wen Sui**, Xuqian Zheng, Ji-Tzuoh Lin, Jaesung Lee, Jim L. Davidson, Robert A. Reed, Ronald D. Schrimpf, Bruce

- W. Alphenaar, Michael L. Alles, Philip X.-L. Feng, "Effects of Ion-Induced Displacement Damage on GaN/AlN MEMS Resonators", *IEEE Transactions on Nuclear Science* **69**, 216-224 (2022). DOI: [10.1109/TNS.2022.3143550](https://doi.org/10.1109/TNS.2022.3143550).
- ♦ **Wen Sui**, Xuqian Zheng, Ji-Tzuoh Lin, Bruce W. Alphenaar, Philip X.-L. Feng, "Thermal Response and TCf of GaN/AlN Heterostructure Multimode Micro String Resonators from -10°C up to 325°C ", *Journal of Microelectromechanical Systems* **30**, 521-529 (2021). DOI: [10.1109/JMEMS.2021.3089703](https://doi.org/10.1109/JMEMS.2021.3089703).
 - ♦ Peilun Yu, **Wen Sui**, Jianchang Li, "Temperature-Dependent Fatigue Failure of Flexible Poly (9,9-dioctylfluorene -alt- benzothiadiazole) (PFBT)-ZnO Nanoparticle Hybrid Resistive Switching Memory Devices", *The Journal of Physical Chemistry C* **24**, 27722-27731 (2021). DOI: [10.1021/acs.jpcc.0c07068](https://doi.org/10.1021/acs.jpcc.0c07068).
 - ♦ **Wen Sui**, Chi Zhang, Heyuan Xu, Jianchang Li, "Mechanical Strain Effects on Resistive Switching of Flexible Polymer Thin Films Embedded with ZnO Nanoparticles", *Materials Research Express* **5**, 066425 (2018). DOI: [10.1088/2053-1591/aacd8a](https://doi.org/10.1088/2053-1591/aacd8a).
 - ♦ Jianchang Li (PI), **Wen Sui**, Yue Li, "Interfacial Effects on Resistive Switching of Vacuum Spray Deposited Polymer Thin Films Embedded with TiO₂ Nanoparticles under Bending Strain", *Organic Electronics* **61**, 170-176 (2018). DOI: [10.1016/j.orgel.2018.05.042](https://doi.org/10.1016/j.orgel.2018.05.042).
 - ♦ **Wen Sui**, Chi Zhang, Jianchang Li, "Design of a Small-Scale Vacuum Fabrication System for Studying Organic Light-Emitting Diodes", *VACUUM*, 56, 6-9 (2018). DOI: [10.13385/j.cnki.vacuum.2019.03.02](https://doi.org/10.13385/j.cnki.vacuum.2019.03.02).
 - ♦ **Wen Sui**, Yue Li, Jianchang Li, "Temperature Dependent Electron Transport in Oligo (3-Methylthiophene) Derivative Molecular Devices", *Organic Electronics* **47**, 1-8 (2017). DOI: [10.1016/j.orgel.2017.04.031](https://doi.org/10.1016/j.orgel.2017.04.031).
 - ♦ Jianchang Li (PI), **Wen Sui**, Yue Li, "Interfacial Effects on Resistive Switching of Polymer Films Embedded with Different Nanomaterials", *The Journal of Physical Chemistry C* **121**, 13723-13728 (2017). DOI: [10.1021/acs.jpcc.7b03116](https://doi.org/10.1021/acs.jpcc.7b03116).
 - ♦ Yue Li, **Wen Sui**, Jianchang Li, "Interfacial Effects on Resistive Switching of Flexible Polymer Thin Films Embedded with TiO₂ Nanoparticles", *The Journal of Physical Chemistry C* **121**, 7944-7950 (2017). DOI: [10.1021/acs.jpcc.7b00690](https://doi.org/10.1021/acs.jpcc.7b00690).
 - ♦ Jianchang Li (PI), Sijia Shao, **Wen Sui**, "A Wide Range Precision Vacuum Air Leakage Valve", Patent #: CN103994232A, filed August 20, 2014.

Peer-Reviewed Conference Papers & PRESENTATIONS

- ♦ **Wen Sui**, Mark Sheplak, Philip X.-L. Feng, "Gallium Nitride MEMS Lamb Wave Resonators Operating at High Temperature Up To 800°C ", *Proc. 37th IEEE International Conference on Micro Electro Mechanical Systems (MEMS 2024)*, Austin, Texas, USA, January 21-25 (2024).
- ♦ **Wen Sui**, Tahmid Kaisar, Haoran Wang, Yihao Wu, Jaesung Lee, Huikai Xie, Philip X.-L. Feng, "Thin Film PZT Multimode Resonant MEMS Temperature Sensor", In *Proc. IEEE SENSORS 2022*, Dallas, Texas, USA, October 30-November 2 (2022). DOI: [10.1109/SENSORS52175.2022.9967330](https://doi.org/10.1109/SENSORS52175.2022.9967330).
- ♦ **Wen Sui**, Haoran Wang, Jaesung Lee, Afzaal Qamar, Mina Rais-Zadeh, Philip X.-L. Feng, "AlScN-on-SiC Diaphragm Multimode Micromechanical Resonators for High-Temperature Sensing Applications", *Proc. International Conference and Exhibition on High Temperature Electronics Network (HiTEN 2022)*, Oxford, United Kingdom, July 18-20 (2022). DOI: [10.4071/001c.89964](https://doi.org/10.4071/001c.89964).
- ♦ **Wen Sui**, Xuqian Zheng, Ji-Tzuoh Lin, Bruce W. Alphenaar, Philip X.-L. Feng, "Temperature Dependence of Multimode Gallium Nitride/Aluminum Nitride (GaN/AlN) Heterostructure String Resonator", *Proc. 34th IEEE International Conference on Micro Electro Mechanical Systems (MEMS 2021)*, 478-481, Gainesville, FL, USA, January 25-29 (2021). DOI: [10.1109/MEMS51782.2021.9375389](https://doi.org/10.1109/MEMS51782.2021.9375389).
- ♦ **Wen Sui**, Haoran Wang, Jaesung Lee, Afzaal Qamar, Mina Rais-Zadeh, Philip X.-L. Feng, "AlScN-on-SiC Thin Film Micromachined Resonant Transducers Operating in High-Temperature Environment up to 600°C ", *Present in Joint Conference of the European Frequency & Time Forum & IEEE Intl Frequency Control*

Symposium (EFTF-IFCS), Paris, France, April 24-28 (2022).

- ♦ **Wen Sui**, Xuqian Zheng, Ji-Tzuoh Lin, Jaesung Lee, Jim L. Davidson, Robert A. Reed, Ronald D. Schrimpf, Bruce W. Alphenaar, Michael L. Alles, Philip X.-L. Feng, “Effects of Ion-Induced Displacement Damage on GaN/AlN MEMS Resonators”, *Present in IEEE Nuclear and Space Radiation Effects Conference (NSREC 2021)*, Virtual, July 19-23 (2021).
- ♦ **Wen Sui**, S M Enamul Hoque Yousuf, Xuqian Zheng, and Philip X.-L. Feng, “Pressure Response and Air Damping of β -Ga₂O₃ Nanomechanical Resonators”, *Present in Joint Conference of the European Frequency & Time Forum & IEEE Intl Frequency Control Symposium (EFTF-IFCS)*, Virtual, July 7-17 (2021). **(Best Paper Finalist)**
- ♦ **Wen Sui**, Fan Ye, Arnob Islam, Jaesung Lee, Philip X.-L. Feng, “Ultrawide Frequency Tuning of Atomic Layer van der Waals Heterostructure Electromechanical Resonators”, *Present in the 67th American Vacuum Society (AVS) International Symposium*, Virtual, October 25-28 (2021).

ACADEMIC COMPETITION

Mathematical Contest in Modeling, USA

2015

Topic: Generic Model for Searching “Missing” Airplanes MH370

- ♦ **Honorable Mention Award**; Leader of a three-member team
- ♦ Build general models to search airliners out of contact by using ordinary differential equation method, the Bayes methods, the analytical hierarch process (AHP), and the geometrical analysis method; and then improved, optimized and validated the models

Undergraduate Mathematical Contest in Modeling, China

2014

- ♦ **1st Prize in Liaoning province**
- ♦ Leader of a three-member team; designed and simulated the dynamic change of creative flat-folding table

LEADERSHIP & SEVERCE ROLES

- ♦ Interdisciplinary Microsystems Group Leadership Council, University of Florida 2020–2022
- ♦ Class Leader, Northeastern University 2016–2019
- ♦ Leader, Study Department in Student Union, Northeastern University 2013–2016

AWARDS & HONORS

Graduate

- ♦ Wilson and Marie Collins Endowment for Graduate Fellowships, ECE, University of Florida 2023
- ♦ IMG Excellence in Research Award, University of Florida 2022
 - ♦ This award is the highest recognition on a student for his or her research and is a mark of academic distinction for IMG students
- ♦ The Finish Line Awards (\$9,000 Fellowship), University of Florida 2022
- ♦ Margaret A. Ross Fellowship, ECE, University of Florida 2020–2022
- ♦ Best Poster Award, NanoDay UF, University of Florida 2021
- ♦ Best Paper Finalist, Joint Conference of the European Frequency & Time Forum & IEEE Intl Frequency Control Symposium (EFTF-IFCS). 2021
- ♦ Outstanding Master’s Thesis in Liaoning Province 2019
- ♦ Outstanding Graduate in Liaoning Province 2019
- ♦ National Scholarship, twice 2017,2018
- ♦ Outstanding Graduate Student in Shenyang City 2018
- ♦ 2018 China Merit Graduate Scholarship, Chinese Vacuum Society, National Level 2018
 - ♦ Awarded to five students each year, the other four from Peking University, Tsinghua University, Chinese

Academy Institute, Hefei University of Technology

- ♦ Advanced Individual in Academic Innovation, twice, Northeastern University 2017,2018
- ♦ Graduate President Scholarship, Northeastern University 2016
- ♦ First-class Scholarship, twice, Northeastern University 2016,2017

Undergraduate

- ♦ Outstanding Graduate in Liaoning Province 2016
- ♦ Outstanding University Student in Shenyang City 2015
- ♦ National Scholarship, twice 2013,2015
- ♦ Zhongbei Tongci Scholarship 2014
 - ♦ Awarded to one student of the department each year who displays excellent in academic study
- ♦ First-class Scholarship, five times, Northeastern University 2012–2016